

BFR740L3RH

SiGe:C NPN RF bipolar transistor



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Technical documents



Simulation



Support

Product description

The BFR740L3RH is a wideband RF heterojunction bipolar transistor (HBT) available in a low profile package.



Feature list

- Low noise figure $NF_{min} = 0.5$ dB at 1.9 GHz 3 V, 6 mA; 0.8 dB at 5.5 GHz, 3 V, 6 mA
- High power gain $G_{ms} = 20$ dB at 5.5 GHz, 3 V, 15 mA
- Low profile and small form factor leadless package

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Wireless communications: WLAN 2.4 GHz and 5-6 GHz bands, WiMax and UWB
- Satellite communication systems: GNSS navigation systems (GPS, GLONASS, BeiDou, Galileo), satellite radio (SDARs, DAB) and C-band LNB
- Multimedia applications such as portable TV, CATV and FM radio
- ISM applications like RKE, AMR and Zigbee, as well as for emerging wireless applications

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration			Marking	Pieces / Reel
BFR740L3RH /BFR740L3RHE6327XTSA1	TSLP-3-9	1 = B	2 = C	3 = E	R9	15000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25\text{ °C}$ (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	-	4.0	V	Open base
			3.5		$T_A = -55\text{ °C}$, open base
Collector emitter voltage	V_{CES}		13		E-B short circuited
Collector base voltage	V_{CBO}		13		Open emitter
Emitter base voltage	V_{EBO}		1.2		Open collector
Base current	I_B		4	mA	-
Collector current	I_C		40		
Total power dissipation ¹⁾	P_{tot}		160	mW	$T_S \leq 105\text{ °C}$
Junction temperature	T_J		150	°C	-
Storage temperature	T_{Stg}	-55			

Attention: *Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.*

¹ T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	-	280	-	K/W	

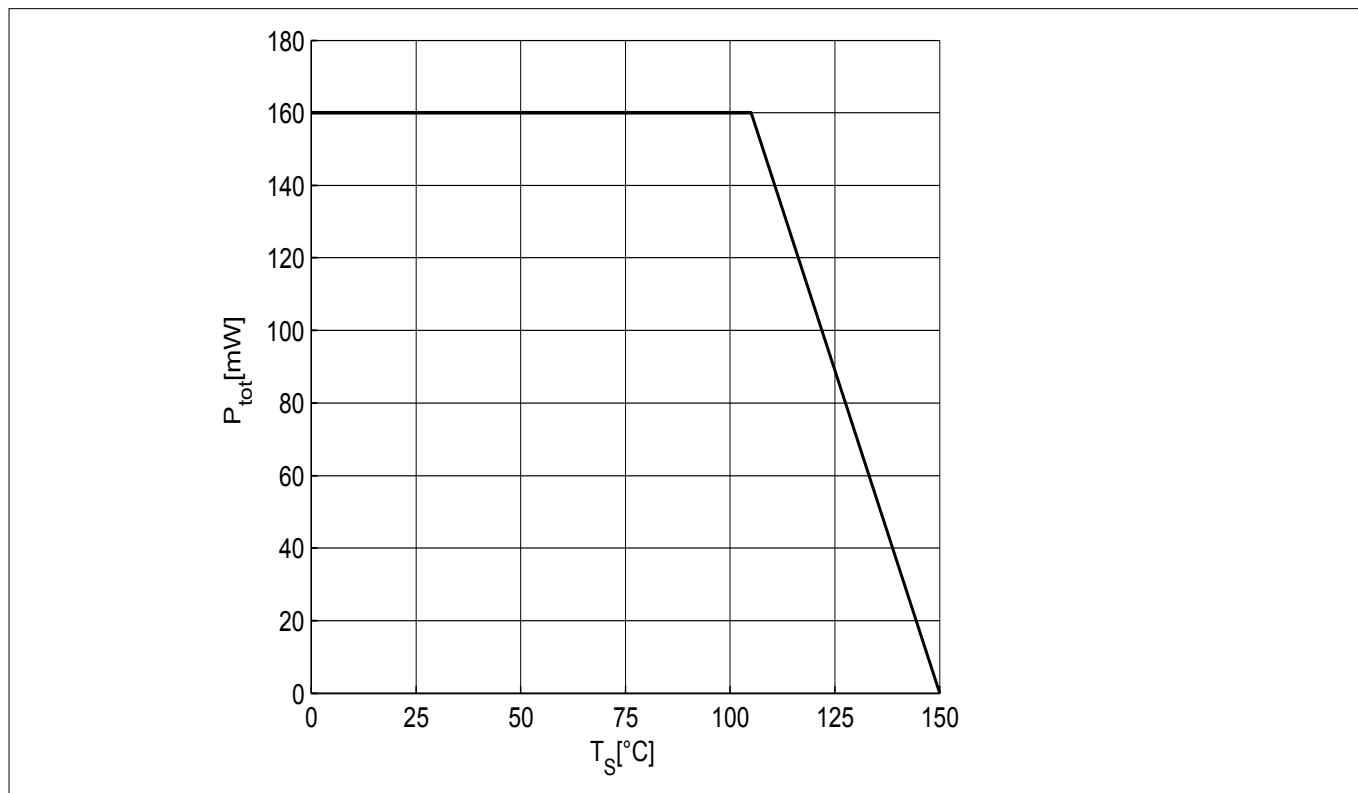


Figure 1 Total power dissipation $P_{tot} = f(T_s)$

Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	4	4.7	–	V	$I_C = 1\text{ mA}$, $I_B = 0$, open base
Collector emitter leakage current	I_{CES}	–	1 1	400 ¹⁾ 40 ¹⁾	nA	$V_{CE} = 13\text{ V}$, $V_{BE} = 0$ $V_{CE} = 5\text{ V}$, $V_{BE} = 0$, E-B short circuited
Collector base leakage current	I_{CBO}		1	40 ¹⁾		$V_{CB} = 5\text{ V}$, $I_E = 0$, open emitter
Emitter base leakage current	I_{EBO}		1	40 ¹⁾		$V_{EB} = 0.5\text{ V}$, $I_C = 0$, open collector
DC current gain	h_{FE}	160	250	400		$V_{CE} = 3\text{ V}$, $I_C = 25\text{ mA}$, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	42	–	GHz	$V_{CE} = 3\text{ V}$, $I_C = 25\text{ mA}$, $f = 2\text{ GHz}$
Collector base capacitance	C_{CB}		0.09	0.12	pF	$V_{CB} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, emitter grounded
Collector emitter capacitance	C_{CE}		0.3	–		$V_{CE} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, base grounded
Emitter base capacitance	C_{EB}		0.4			$V_{EB} = 0.5\text{ V}$, $V_{CB} = 0$, $f = 1\text{ MHz}$, collector grounded

¹ Maximum values not limited by the device but by the short cycle time of the 100% test.

Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_A = 25\text{ °C}$.

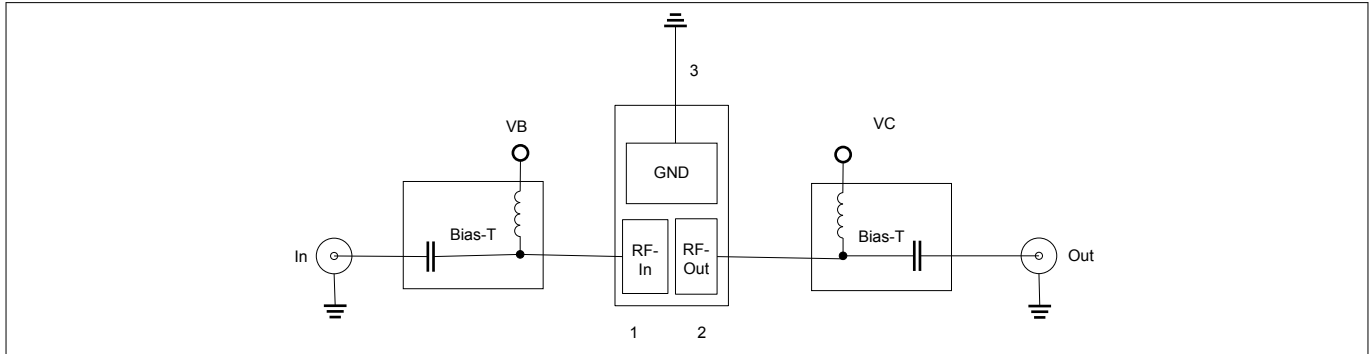


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 150\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		-		-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 	G_{ms} $ S_{21} ^2$		35 29.5			
Noise figure						$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 	NF_{min} G_{ass}	0.45 27.5				
Linearity					dBm	$Z_S = Z_L = 50\text{ }\Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 	OIP_3 OP_{1dB}	21 3.5				

Table 7 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 450\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		-		-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 	G_{ms} $ S_{21} ^2$		31 29			
Noise figure						$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 	NF_{min} G_{ass}	0.45 26.5				
Linearity					dBm	$Z_S = Z_L = 50\text{ }\Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 	OIP_3 OP_{1dB}	21 7				

Electrical characteristics

Table 8 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 900\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	28	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			27			
Noise figure	NF_{min} G_{ass}		0.45			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			25			
Linearity	OIP_3 OP_{1dB}		22.5		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			8			

Table 9 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 1.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	25.5	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			25			
Noise figure	NF_{min} G_{ass}		0.5			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			22.5			
Linearity	OIP_3 OP_{1dB}		23		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			8			

Table 10 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 1.9\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	24.5	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			23.5			
Noise figure	NF_{min} G_{ass}		0.5			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			21			
Linearity	OIP_3 OP_{1dB}		23		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			8			

Electrical characteristics

Table 11 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 2.4\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	23.5	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			21.5			
Noise figure	NF_{min} G_{ass}		0.5			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			19.5			
Linearity	OIP_3 OP_{1dB}		23		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			8			

Table 12 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 3.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	22	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			18.5			
Noise figure	NF_{min} G_{ass}		0.6			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			16.5			
Linearity	OIP_3 OP_{1dB}		24.5		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			9			

Table 13 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 5.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ms} $ S_{21} ^2$	-	20	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 			14.5			
Noise figure	NF_{min} G_{ass}		0.8			$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 			13			
Linearity	OIP_3 OP_{1dB}		25		dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 			9.5			

Electrical characteristics

Table 14 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 10\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ma} $ S_{21} ^2$	-	13	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 						
Noise figure	NF_{min} G_{ass}		1.3	8.5		$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 						
Linearity	OIP_3 OP_{1dB}		24	9	dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 						

Table 15 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 12\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain	G_{ma} $ S_{21} ^2$	-	11	-	dB	$I_C = 15\text{ mA}$
<ul style="list-style-type: none"> Maximum power gain Transducer gain 						
Noise figure	NF_{min} G_{ass}		1.5	7.5		$I_C = 6\text{ mA}$
<ul style="list-style-type: none"> Minimum noise figure Associated gain 						
Linearity	OIP_3 OP_{1dB}		20.5	6.5	dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
<ul style="list-style-type: none"> 3rd order intercept point at output 1 dB gain compression point at output 						

Note: $G_{ms} = |S_{21} / S_{12}|$ for $k < 1$; $G_{ma} = |S_{21} / S_{12}|(k - (k^2 - 1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is $50\ \Omega$ from 0.2 MHz to 12 GHz.

Electrical characteristics

3.4 Characteristic DC diagrams

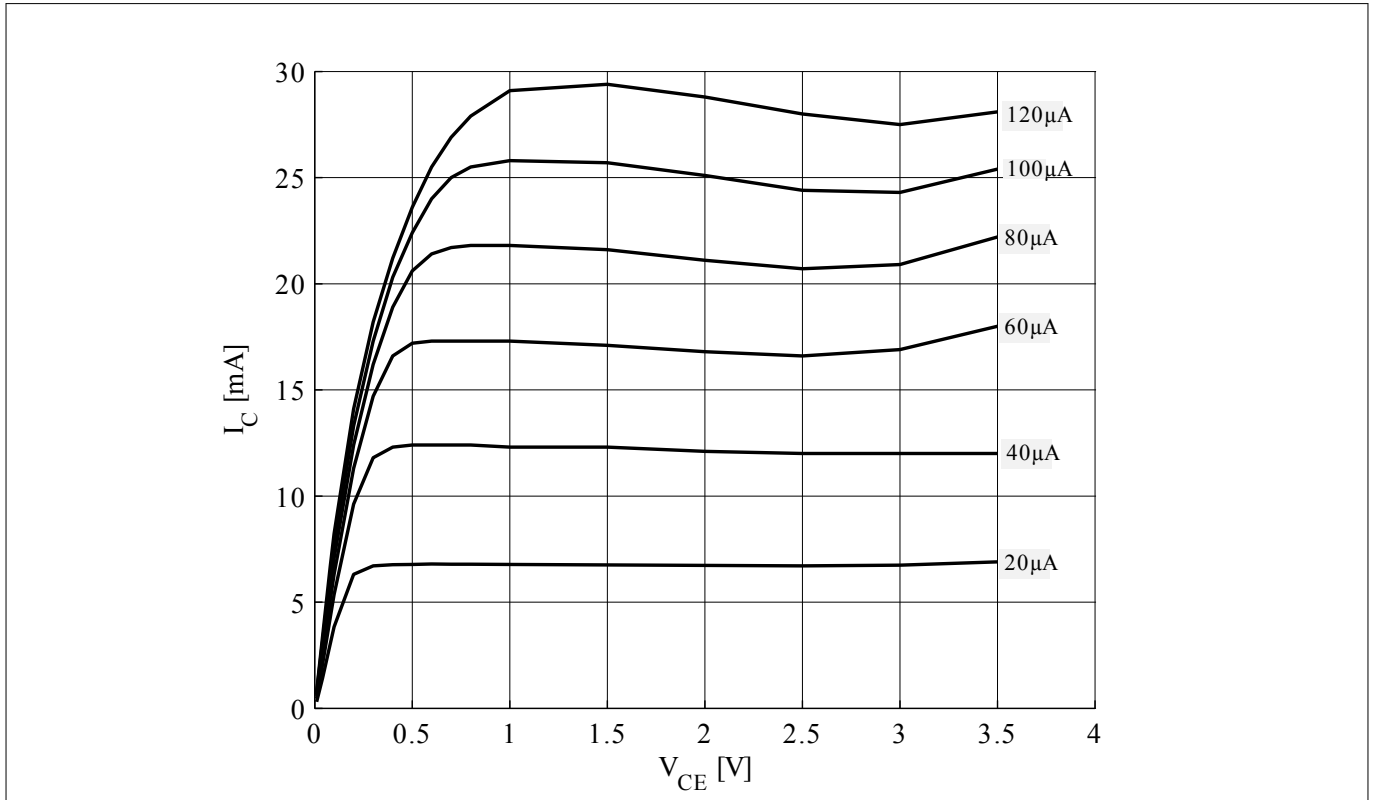


Figure 3 Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, $I_B =$ parameter

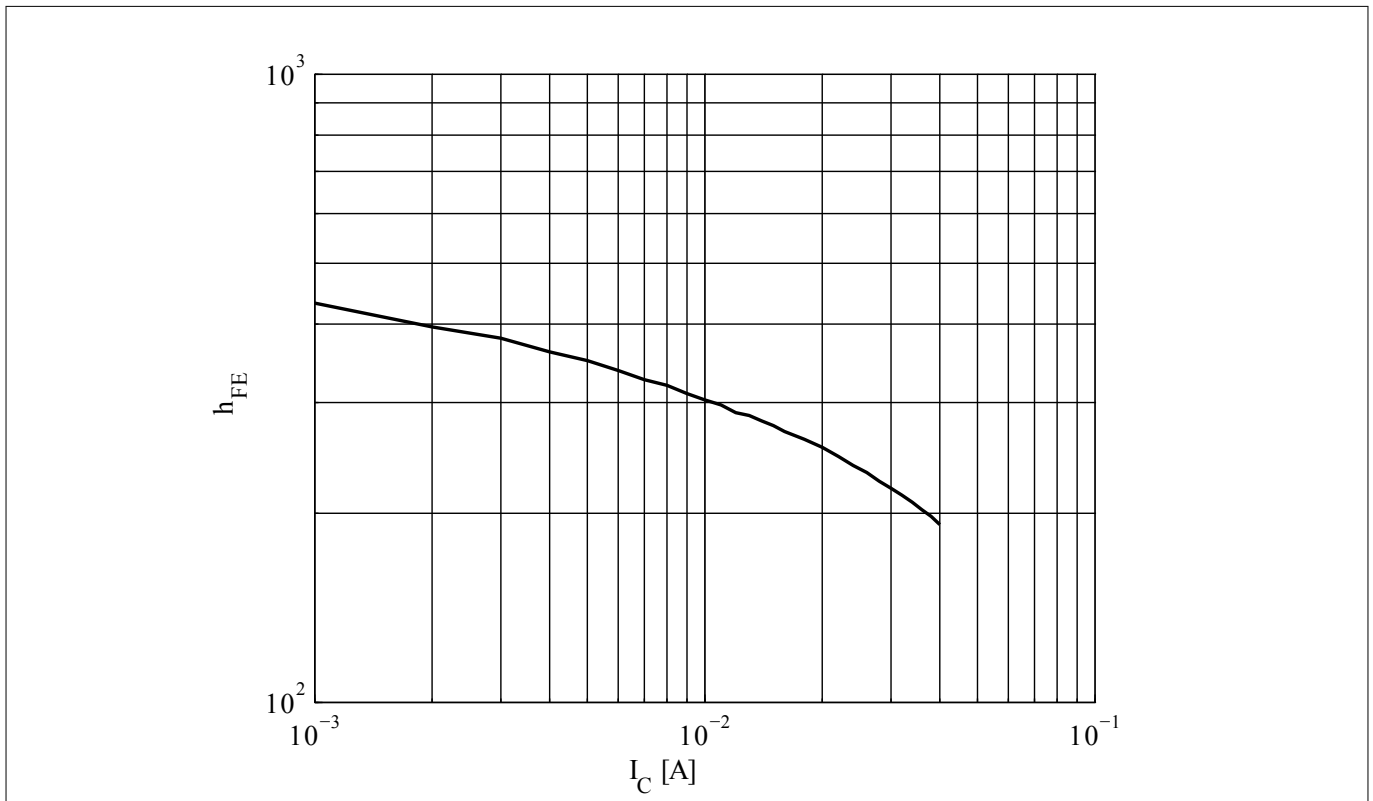


Figure 4 DC current gain $h_{FE} = f(I_C)$, $V_{CE} = 3$ V

Electrical characteristics

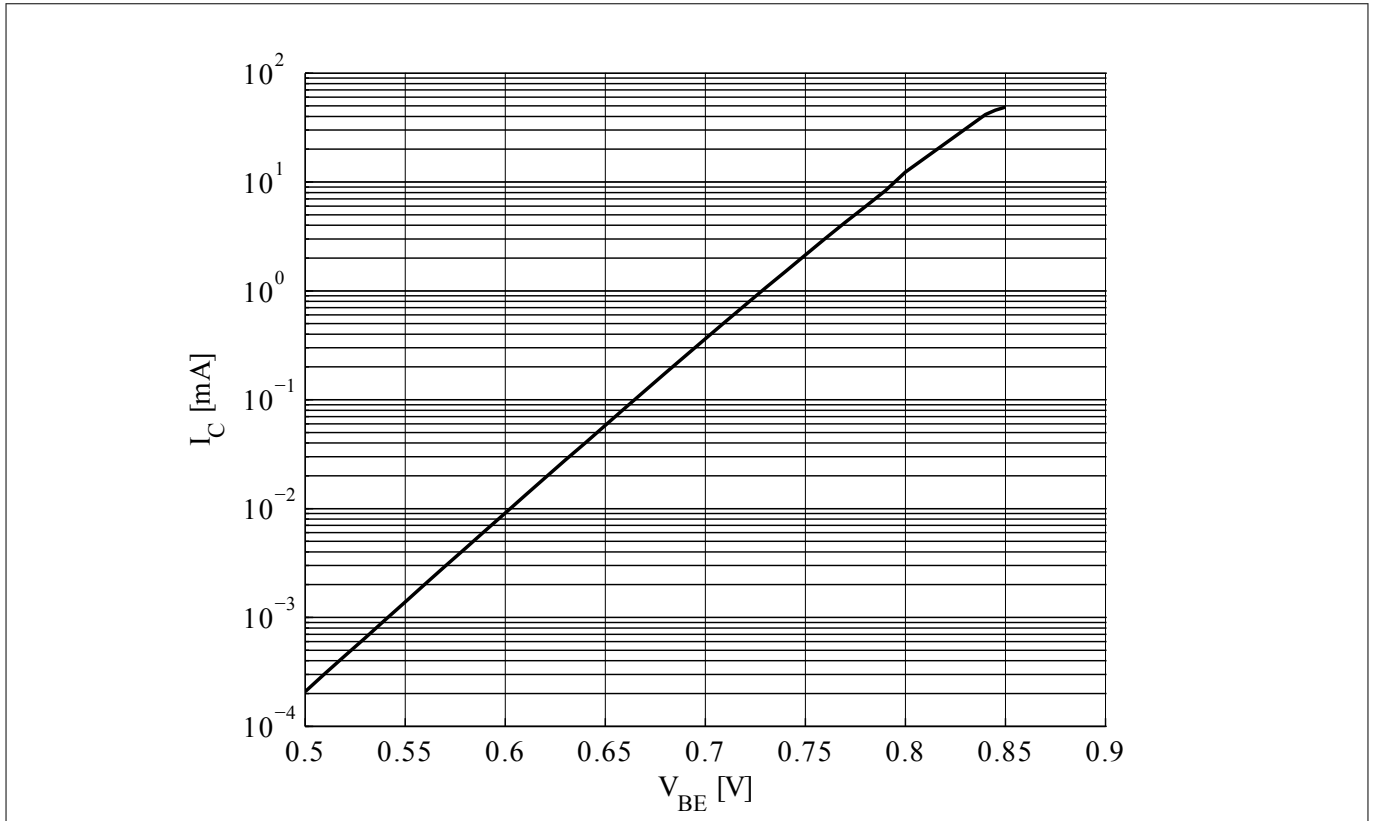


Figure 5 Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 2\text{ V}$

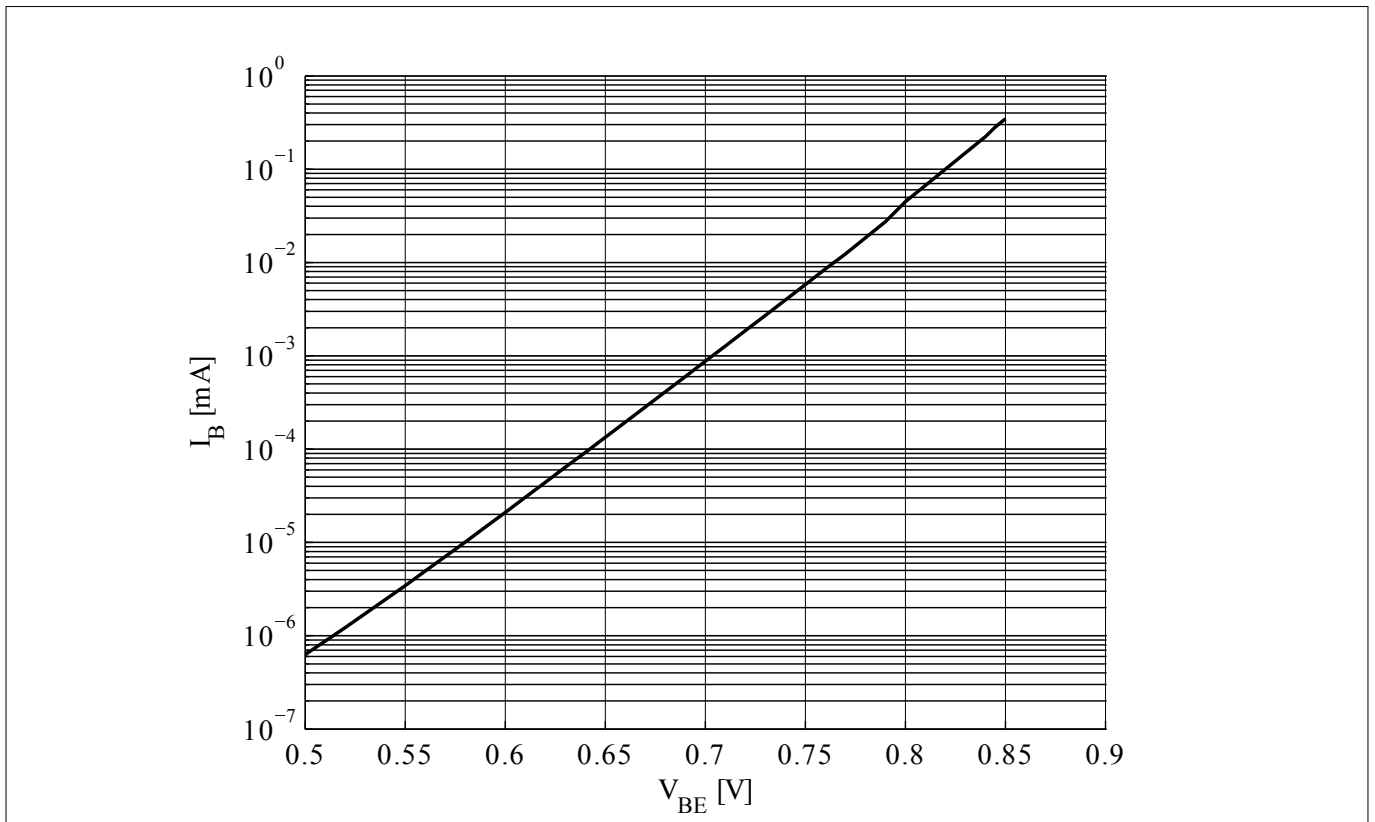


Figure 6 Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 2\text{ V}$

Electrical characteristics

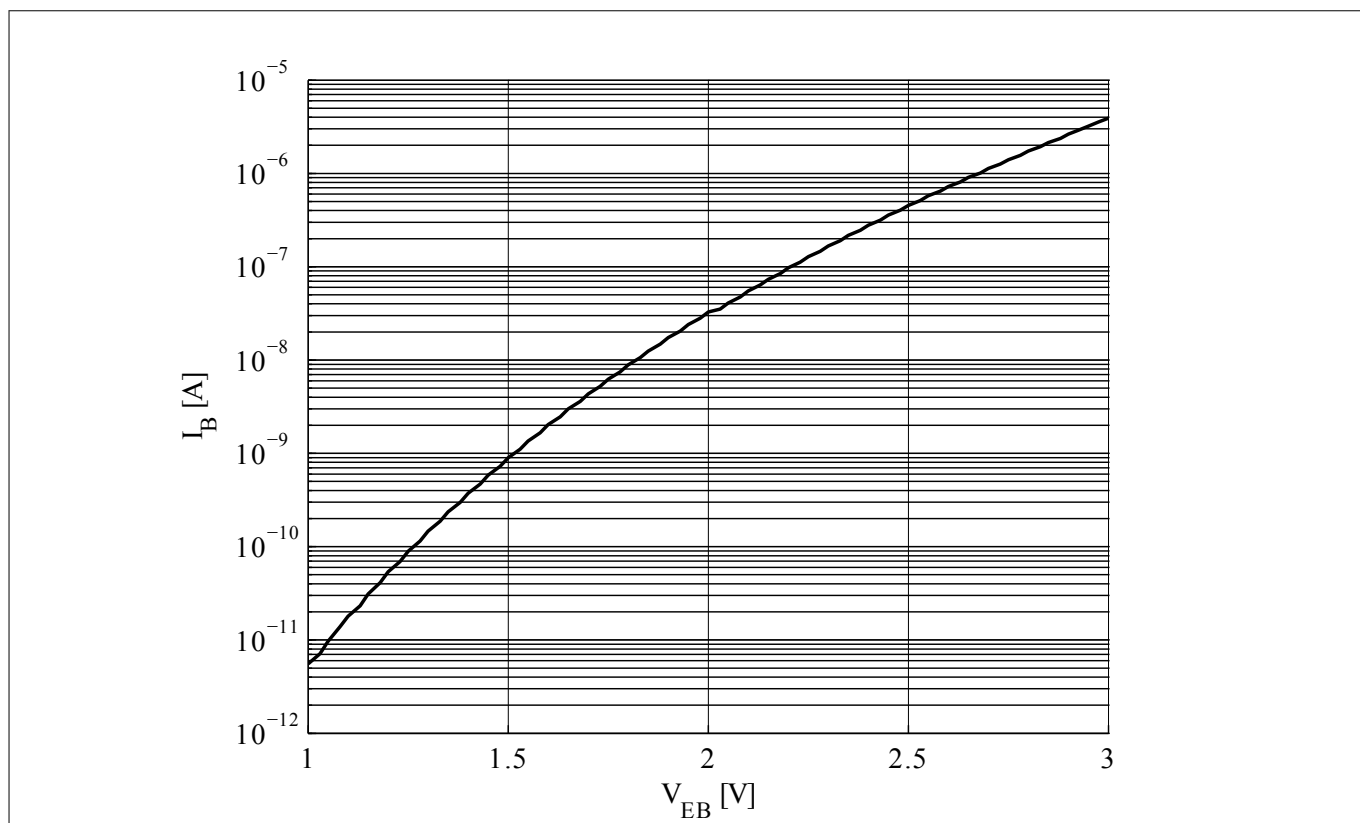


Figure 7 Base current vs. base emitter reverse voltage $I_B = f(V_{EB}), V_{CE} = 2\text{ V}$

Electrical characteristics

3.5 Characteristic AC diagrams

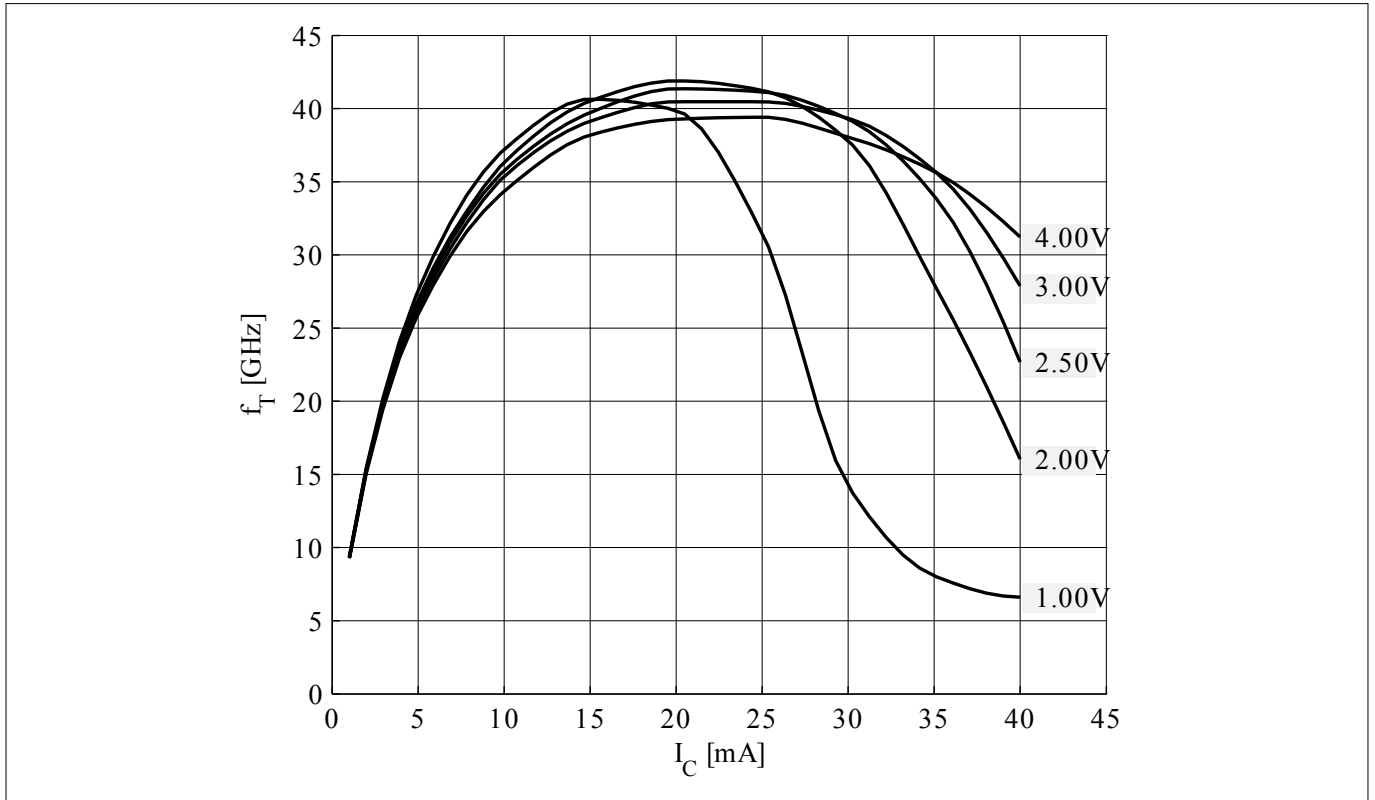


Figure 8 Transition frequency $f_T = f(I_C)$, $f = 2$ GHz, $V_{CE} =$ parameter

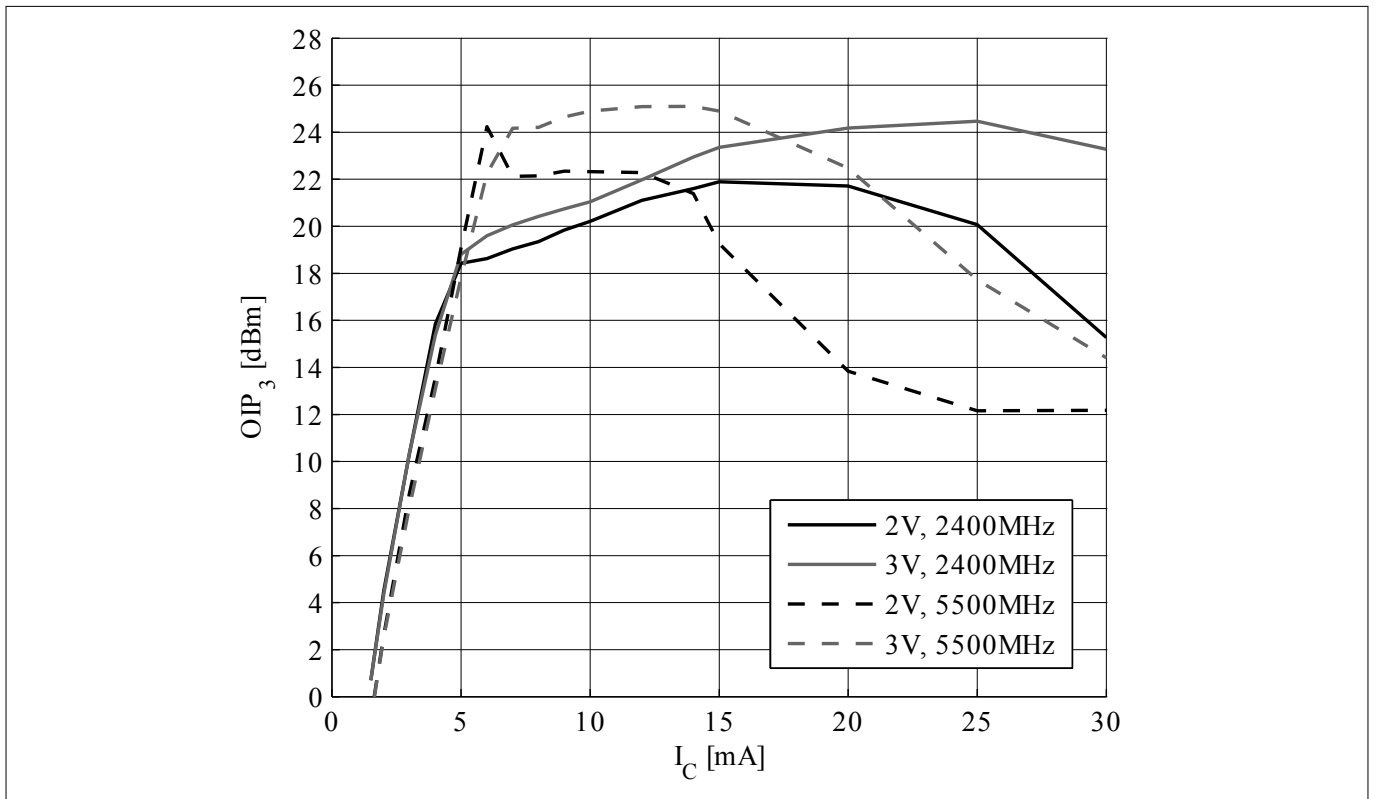


Figure 9 3rd order intercept point at output $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , $f =$ parameter

Electrical characteristics

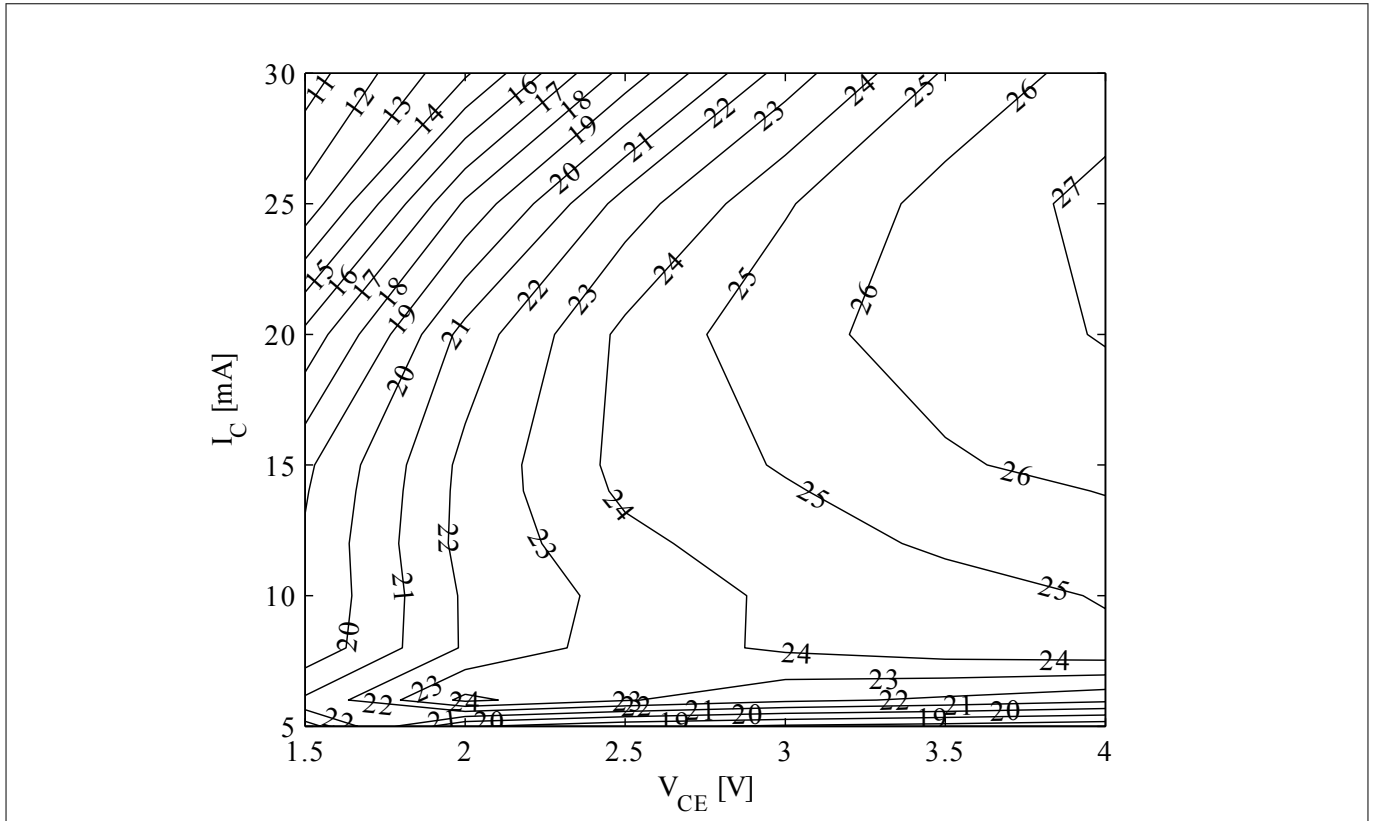


Figure 10 3rd order intercept point at output OIP_3 [dBm] = $f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 5.5$ GHz

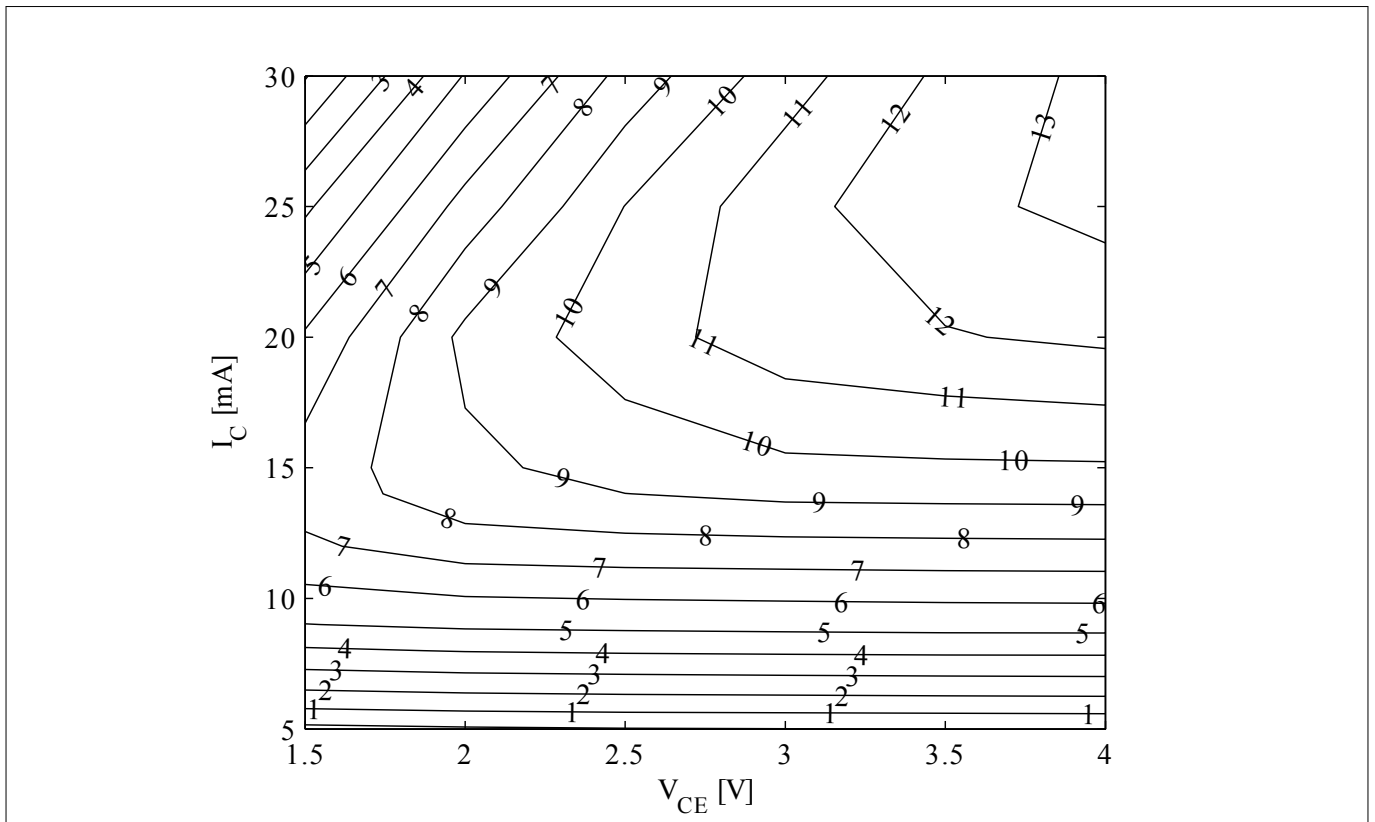


Figure 11 Compression point at output OP_{1dB} [dBm] = $f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 5.5$ GHz

Electrical characteristics

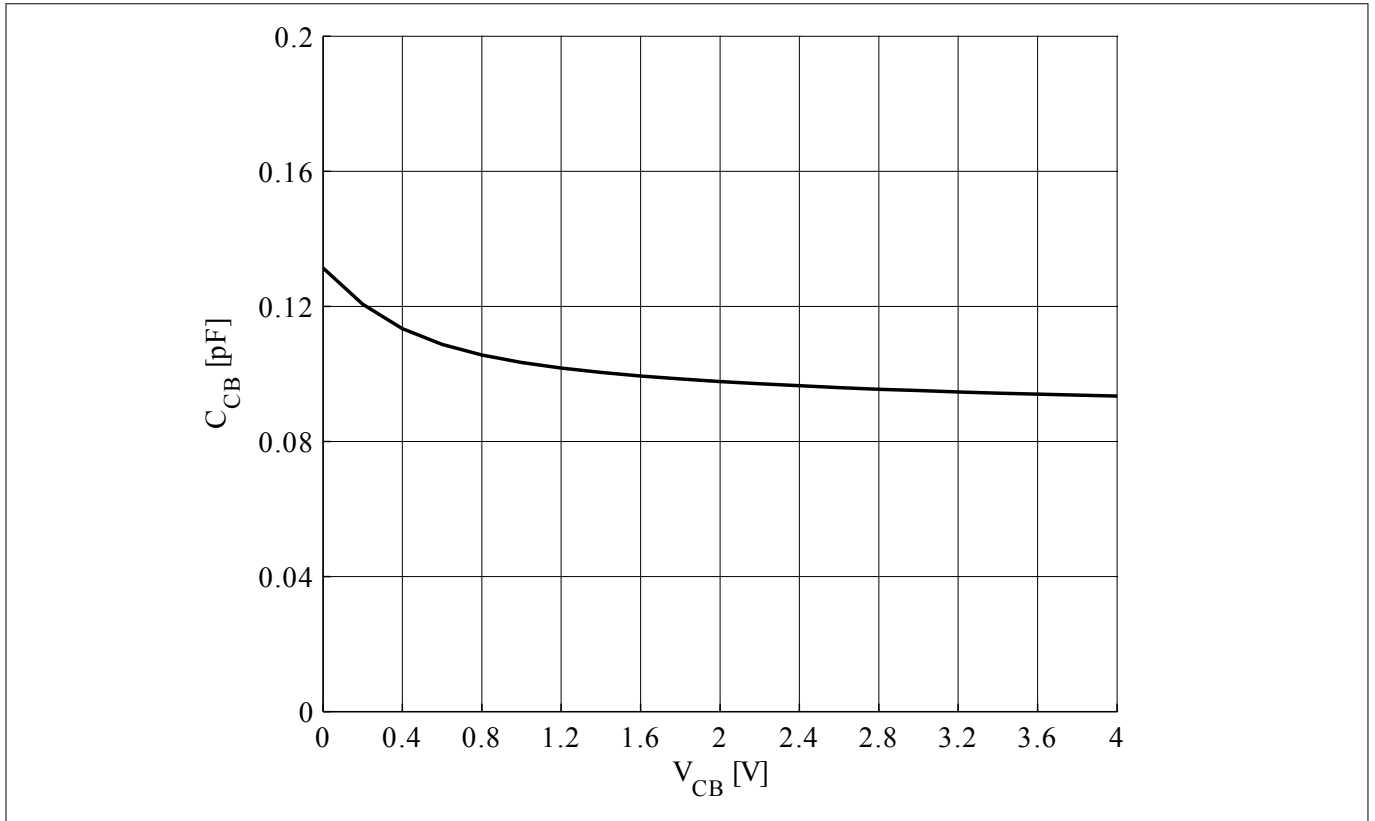


Figure 12 Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1$ MHz

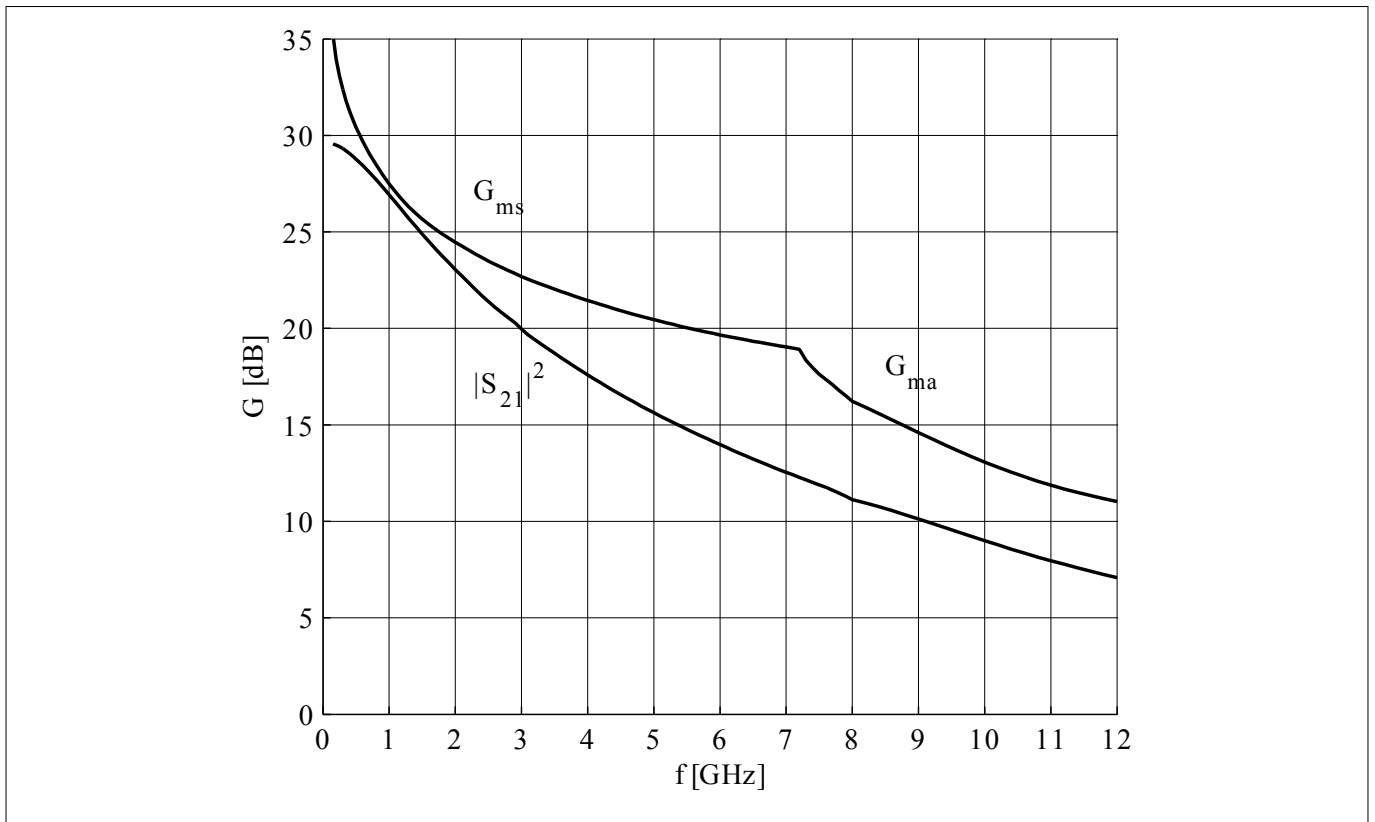


Figure 13 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 3$ V, $I_C = 15$ mA

Electrical characteristics

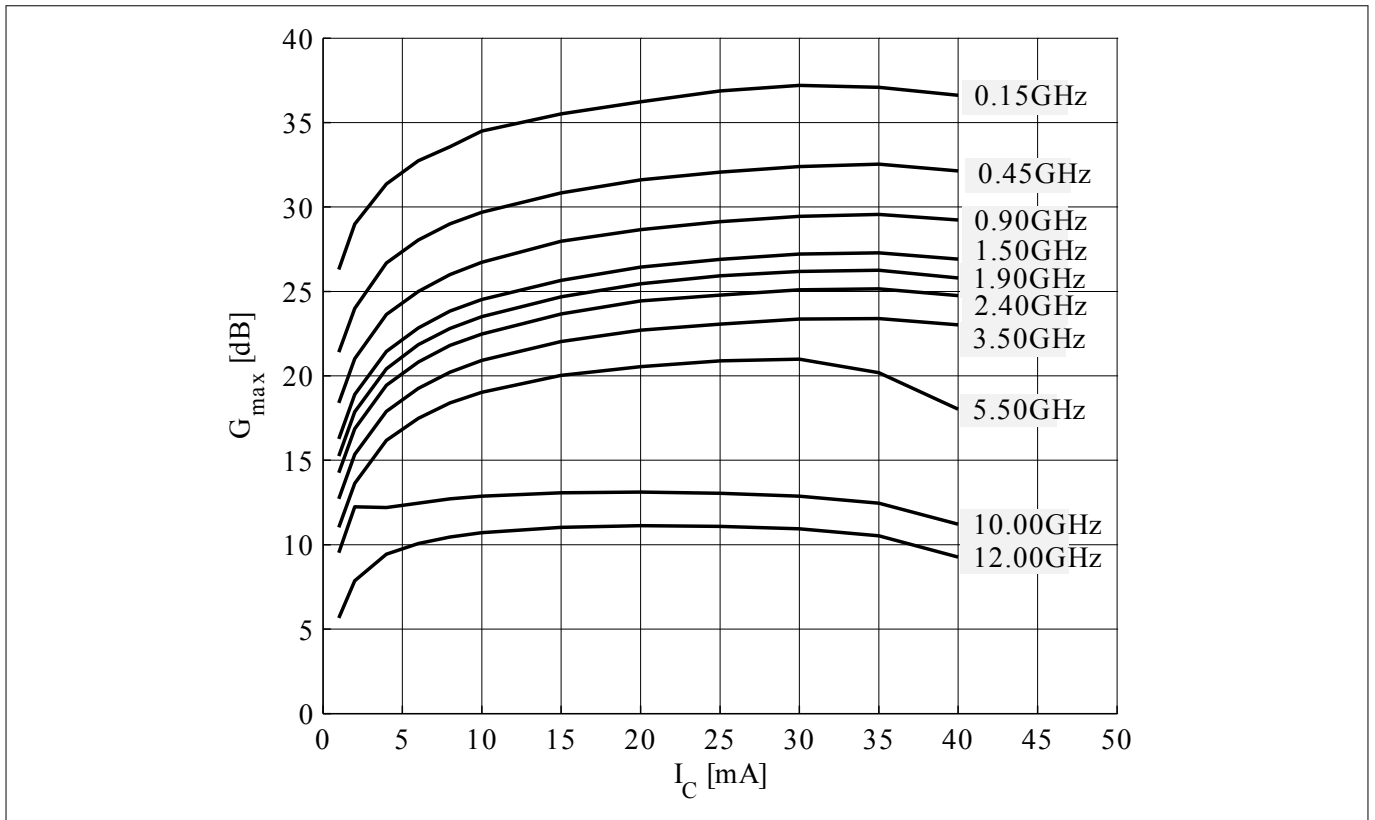


Figure 14 Maximum power gain $G_{max} = f(I_C)$, $V_{CE} = 3\text{ V}$, $f = \text{parameter}$

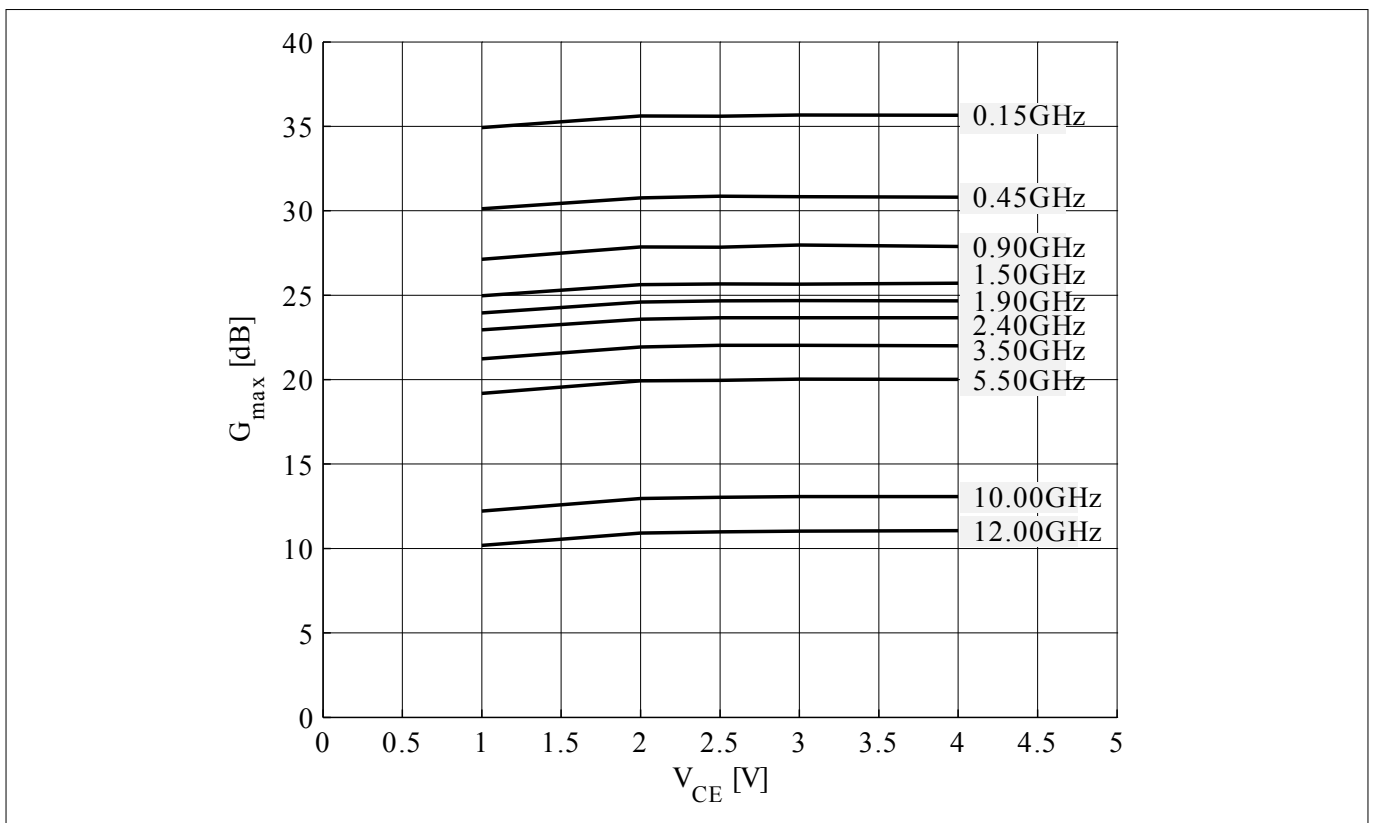


Figure 15 Maximum power gain $G_{max} = f(V_{CE})$, $I_C = 15\text{ mA}$, $f = \text{parameter}$

Electrical characteristics

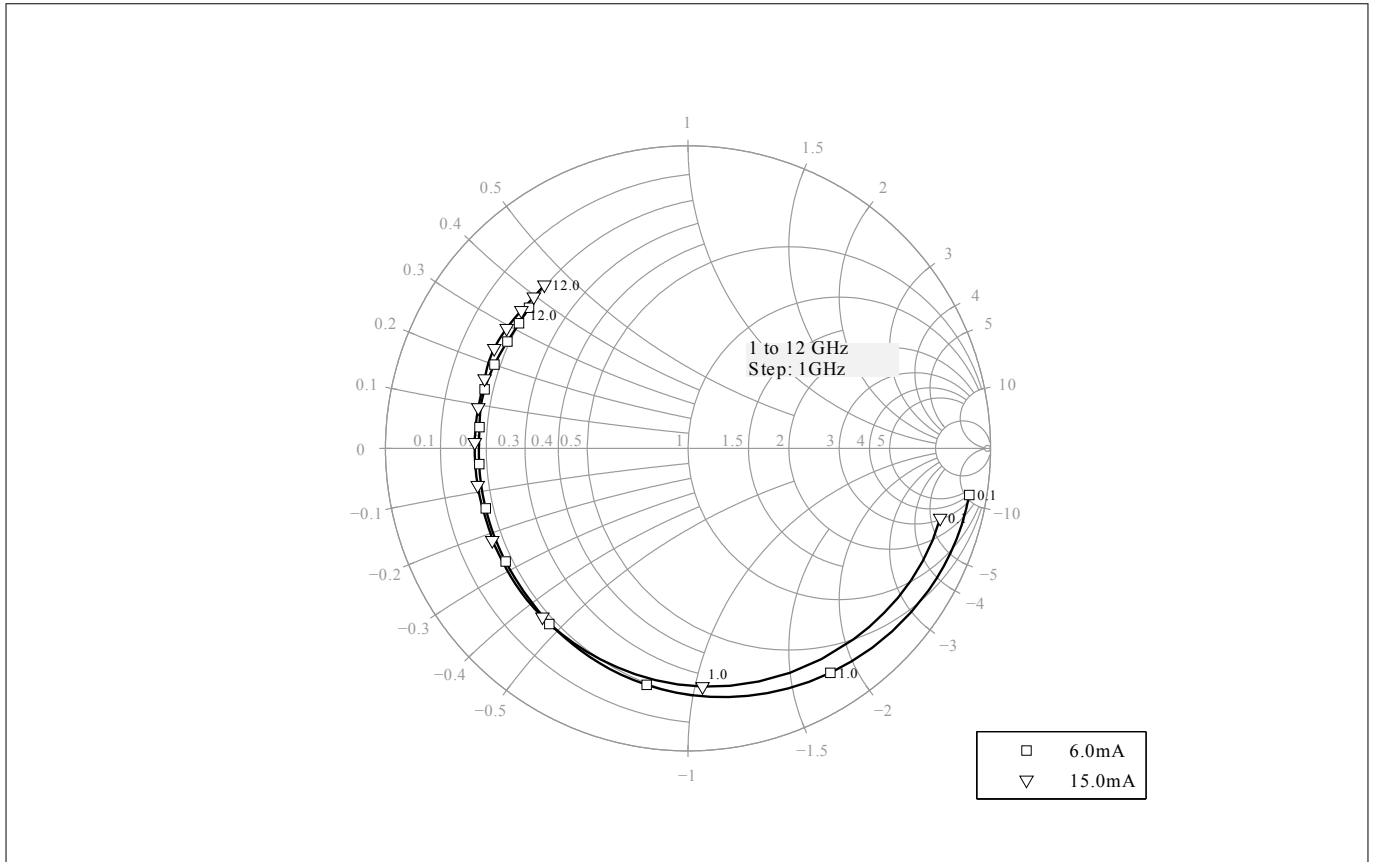


Figure 16 Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 15\text{ mA}$

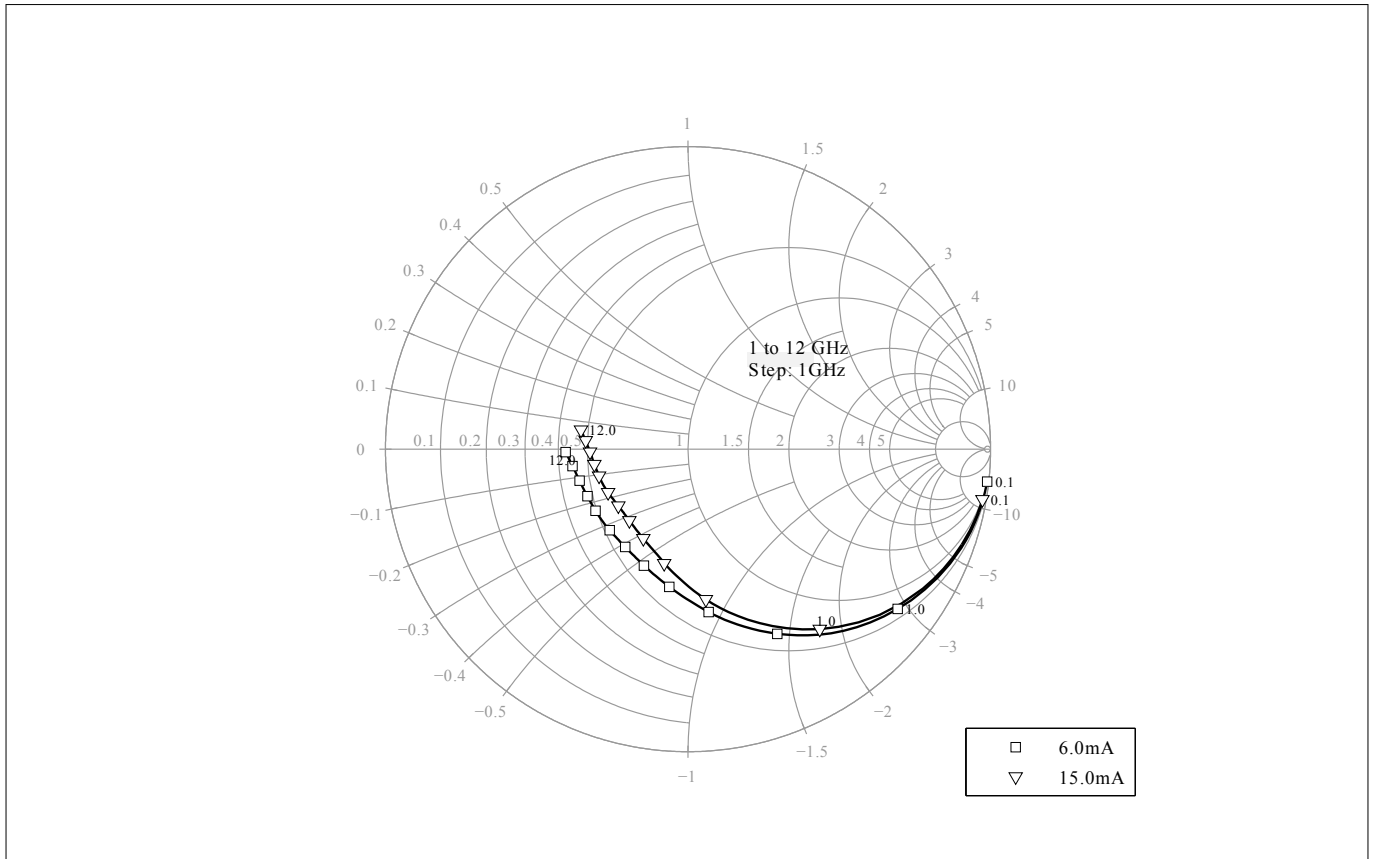


Figure 17 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 15\text{ mA}$

Electrical characteristics

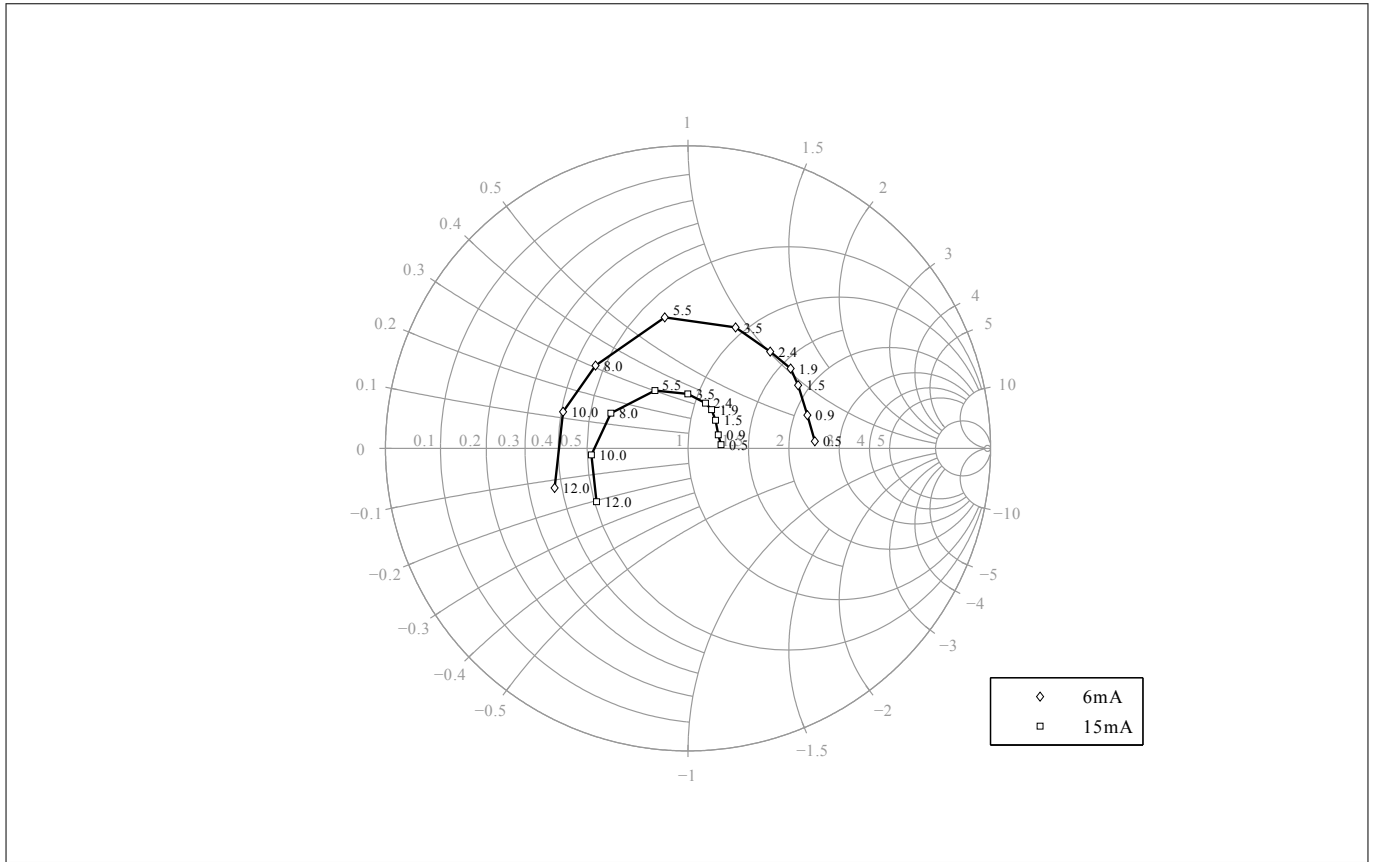


Figure 18 Source impedance for minimum noise figure $Z_{S,opt} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 15\text{ mA}$

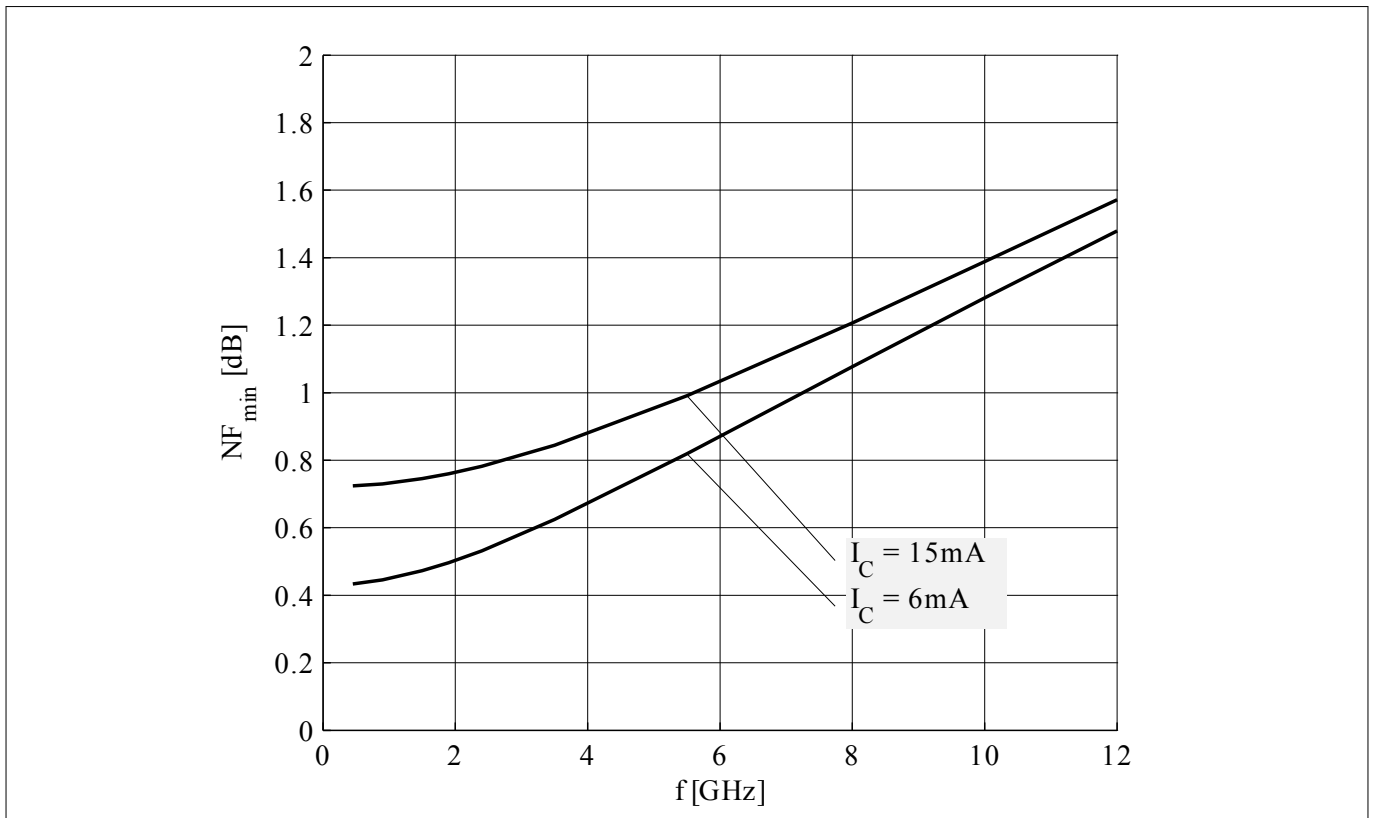


Figure 19 Noise figure $NF_{min} = f(f)$, $V_{CE} = 3\text{ V}$, $Z_S = Z_{S,opt}$, $I_C = 6 / 15\text{ mA}$

Electrical characteristics

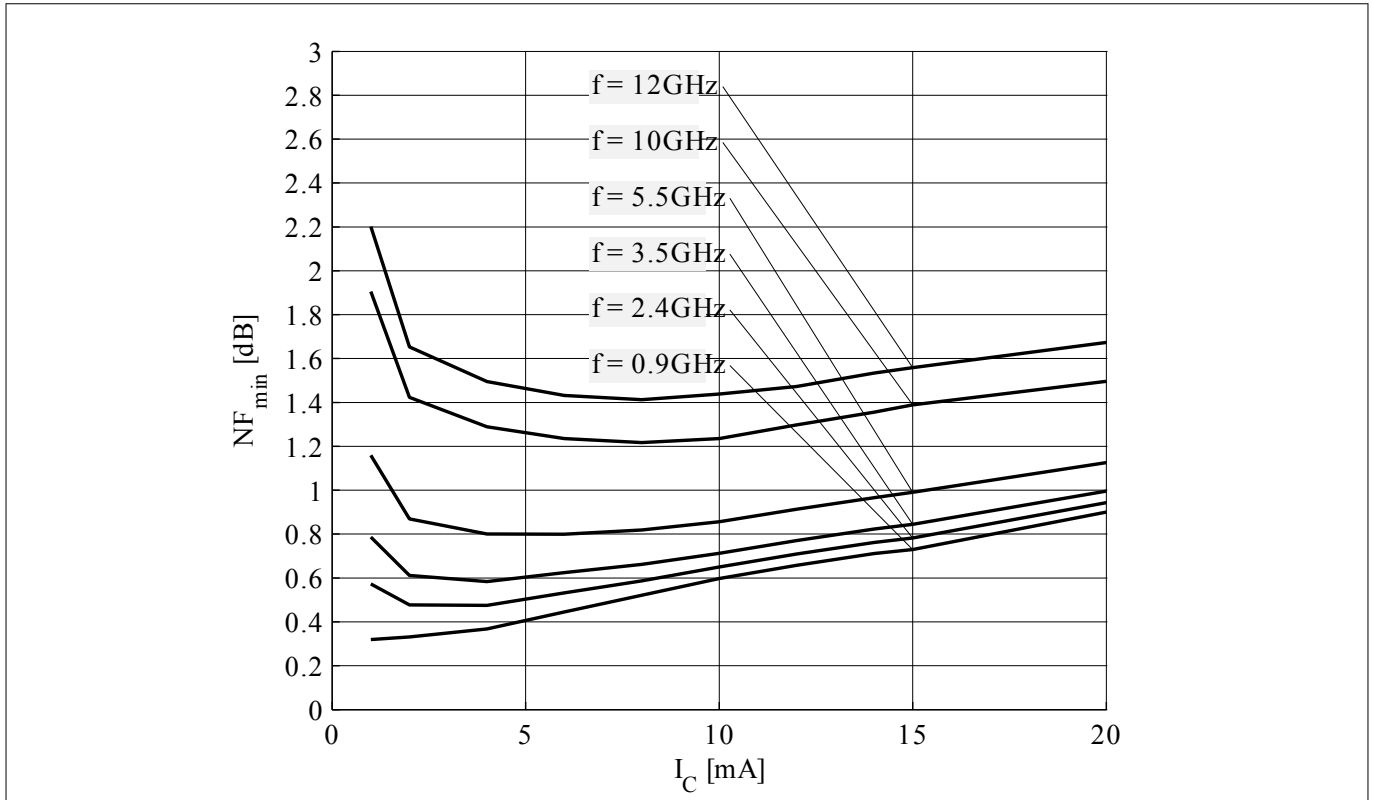


Figure 20 Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 3\text{ V}$, $Z_S = Z_{S,opt}$, $f = \text{parameter}$

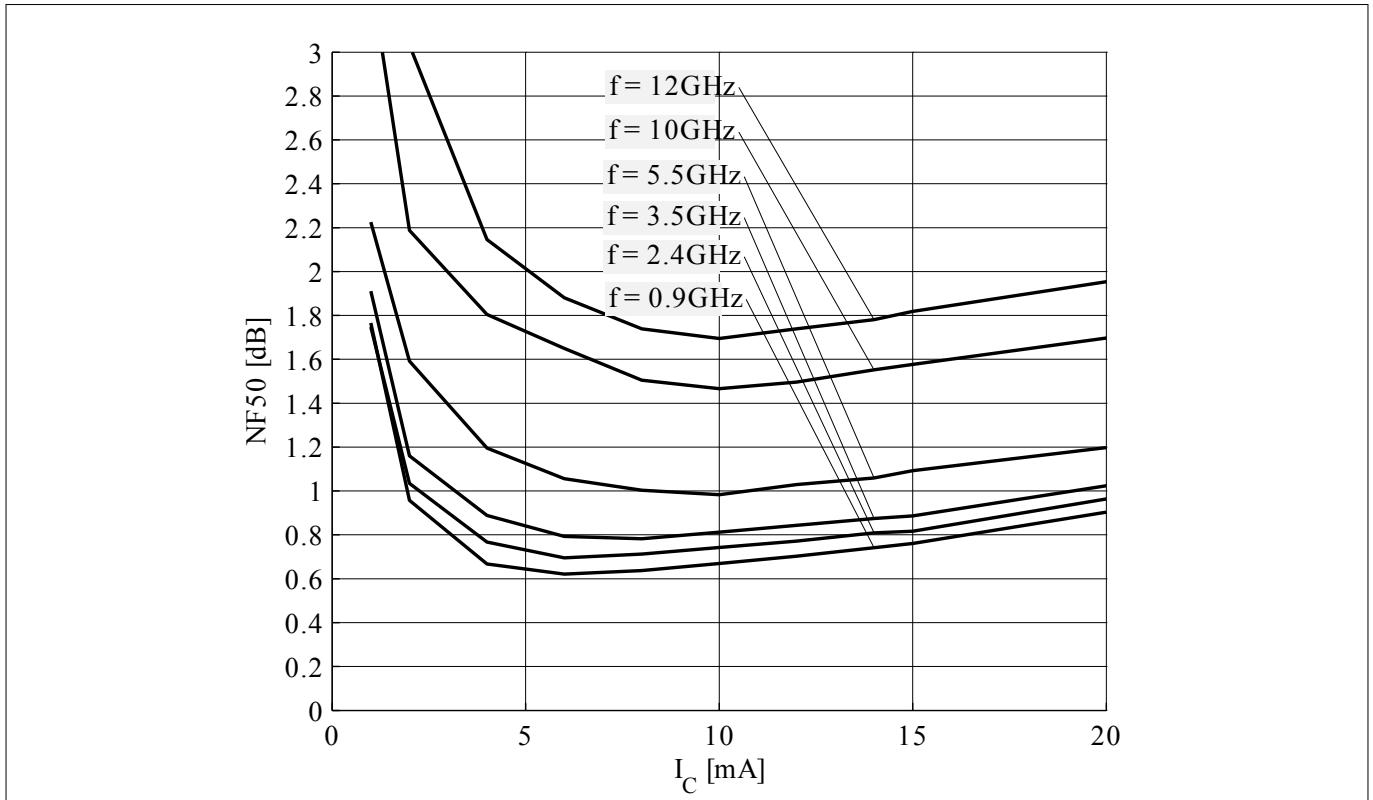


Figure 21 Noise figure $NF_{50} = f(I_C)$, $V_{CE} = 3\text{ V}$, $Z_S = 50\ \Omega$, $f = \text{parameter}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25\text{ }^\circ\text{C}$.

4 Package information TSLP-3-9

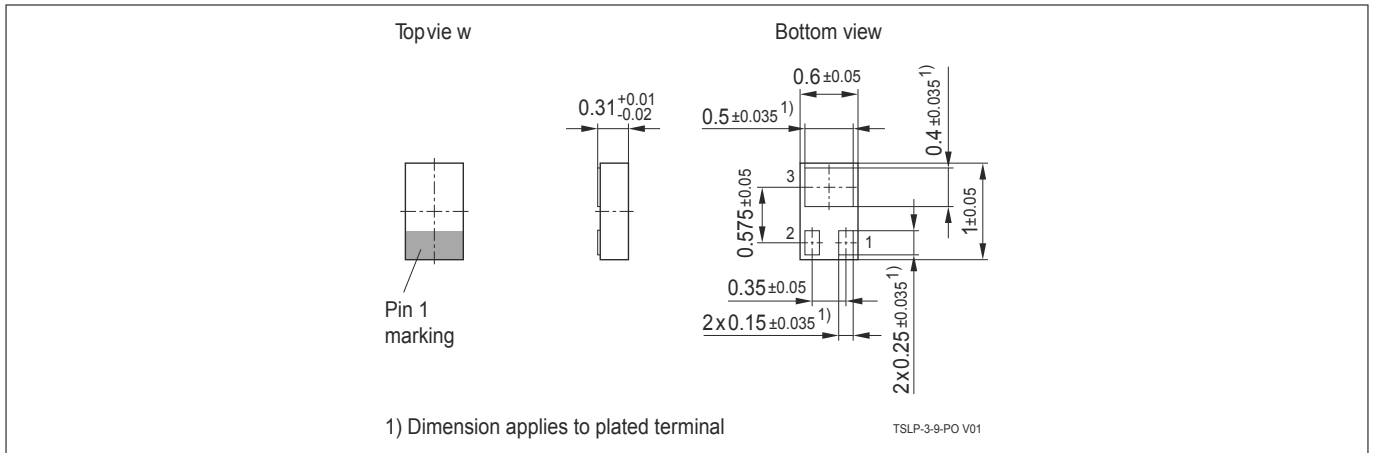


Figure 22 Package outline (dimension in mm)

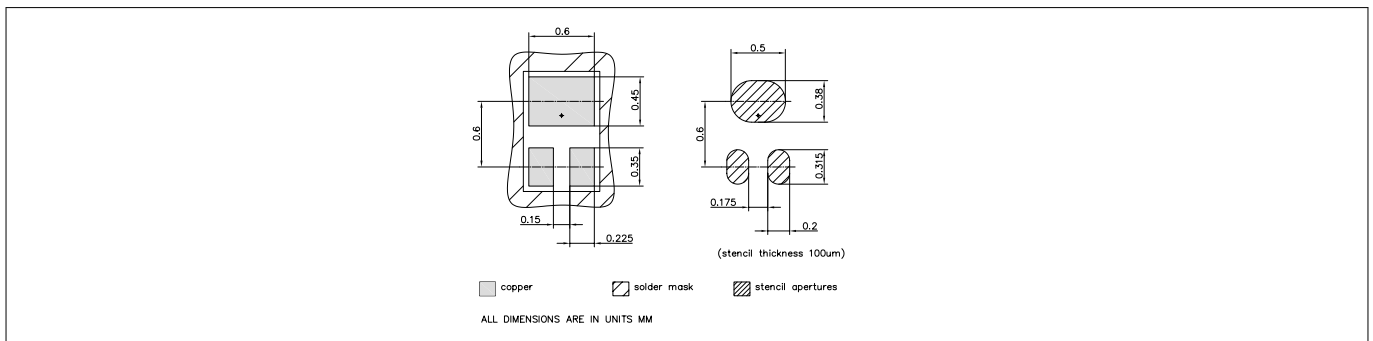


Figure 23 Foot print

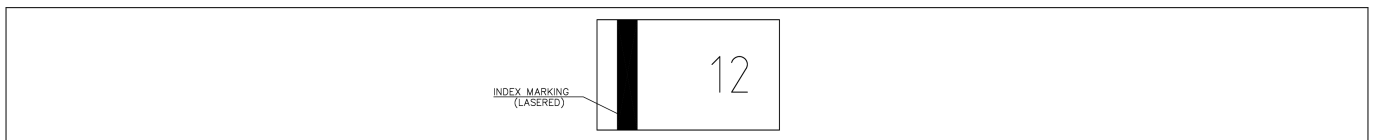


Figure 24 Marking layout example

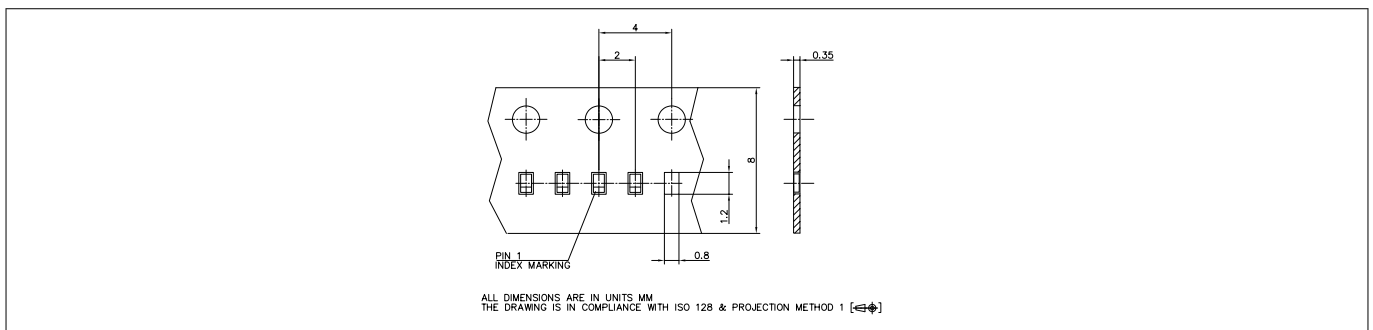


Figure 25 Tape dimensions

Note: See our [Recommendations for Printed Circuit Board Assembly of TSLP/TSSLP/TSNP Packages](#). The marking layout is an example. For the real marking code refer to the device information on the first page. The number of characters shown in the layout example is not necessarily the real one. The marking layout can consist of less characters.

Revision history

Revision history

Document version	Date of release	Description of changes
2.0	2018-09-26	New datasheet layout.

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